



Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
50V	0.9Ω@10V	0.34A
	1.0Ω@4.5V	

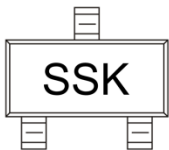
Feature

- High density cell design for extremely low $R_{DS(on)}$
- Rugged and Reliable

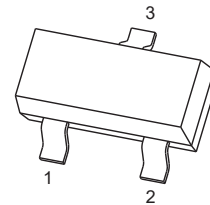
Application

- Direct Logic-Level Interface: TTL/CMOS
- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- Battery Operated Systems
- Solid-State Relays

MARKING:

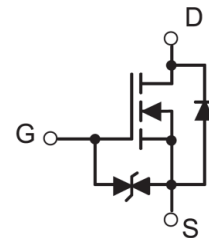


SOT-23



1. GATE
2. SOURCE
3. DRAIN

Schematic diagram



ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	50	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	0.34	A
Pulsed Drain Current	I_{DM}	1.36	A
Power Dissipation	P_D	0.35	W
Thermal Resistance from Junction to Ambient ⁶	$R_{\theta JA}$	357	$^\circ\text{C/W}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~ +150	$^\circ\text{C}$

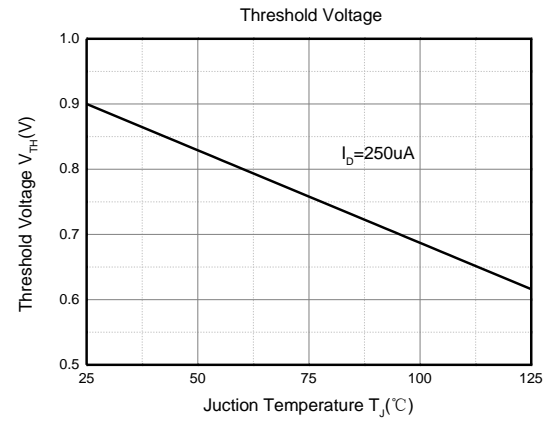
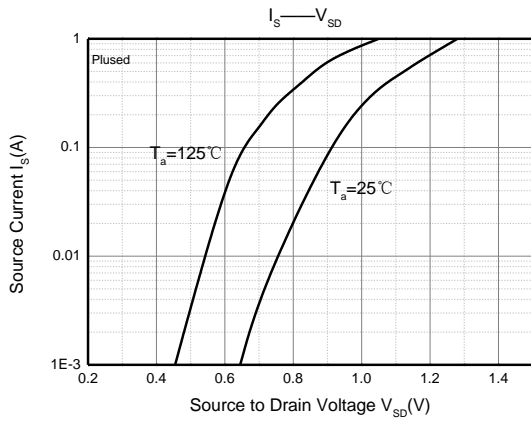
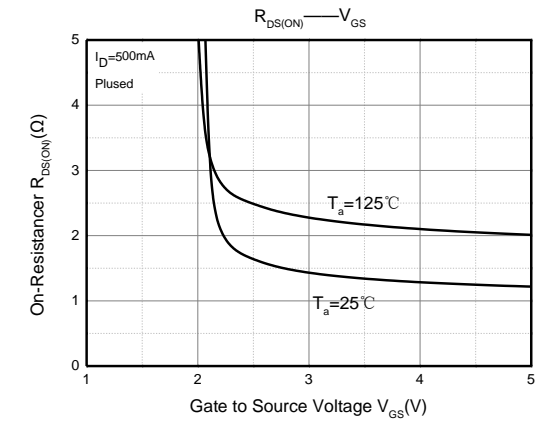
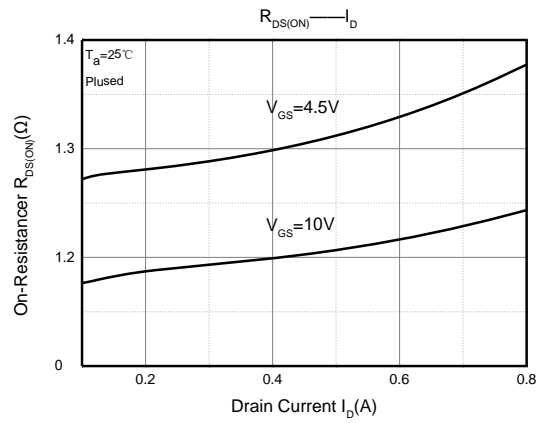
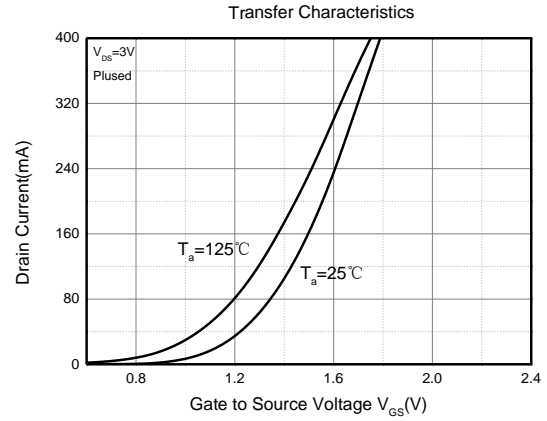
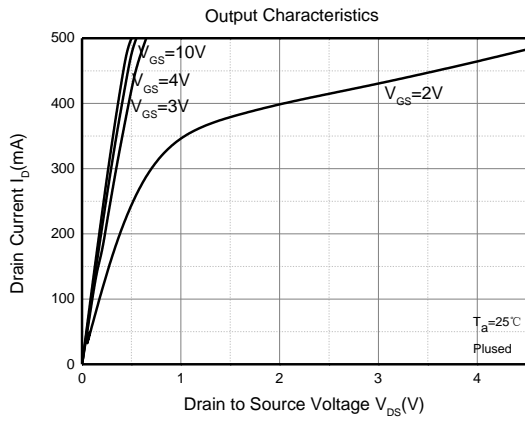
MOSFET ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	50			V
Zero Gate Voltage Drain Current	I _{DSS1}	V _{DS} = 50V, V _{GS} = 0V			0.5	μA
	I _{DSS2}	V _{DS} = 30V, V _{GS} = 0V			100	nA
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±10	μA
Gate Threshold Voltage ¹	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	0.8	1.1	1.5	V
Drain-Source On-Resistance ¹	R _{DS(on)}	V _{GS} = 10V, I _D = 0.22A		0.9	1.8	Ω
		V _{GS} = 4.5V, I _D = 0.22A		1.0	2.0	
Forward Transconductance ¹	g _{FS}	V _{DS} = 10V, I _D = 0.22A		0.13		S
Dynamic Characteristics²						
Input Capacitance	C _{iss}	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		26.5		pF
Output Capacitance	C _{oss}			12.9		
Reverse Transfer Capacitance	C _{rss}			5.9		
Switching Characteristics^{1,2}						
Total Gate Charge	Q _g	V _{DS} = 25V, V _{GS} = 10V, I _D = 0.2A		2.5		nC
Gate-Source Charge	Q _{gs}			0.5		
Gate-Drain Charge	Q _{gd}			0.9		
Turn-On Delay Time	t _{d(on)}	V _{DD} = 25V, V _{GS} = 10V, R _G = 6Ω, I _D = 0.3A		4		ns
Turn-On Rise Time	t _r			18		
Turn-Off Delay Time	t _{d(off)}			10		
Turn-Off Fall Time	t _f			45		
Source-Drain Diode Characteristics¹						
Diode Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 0.44A		1.15	1.4	V

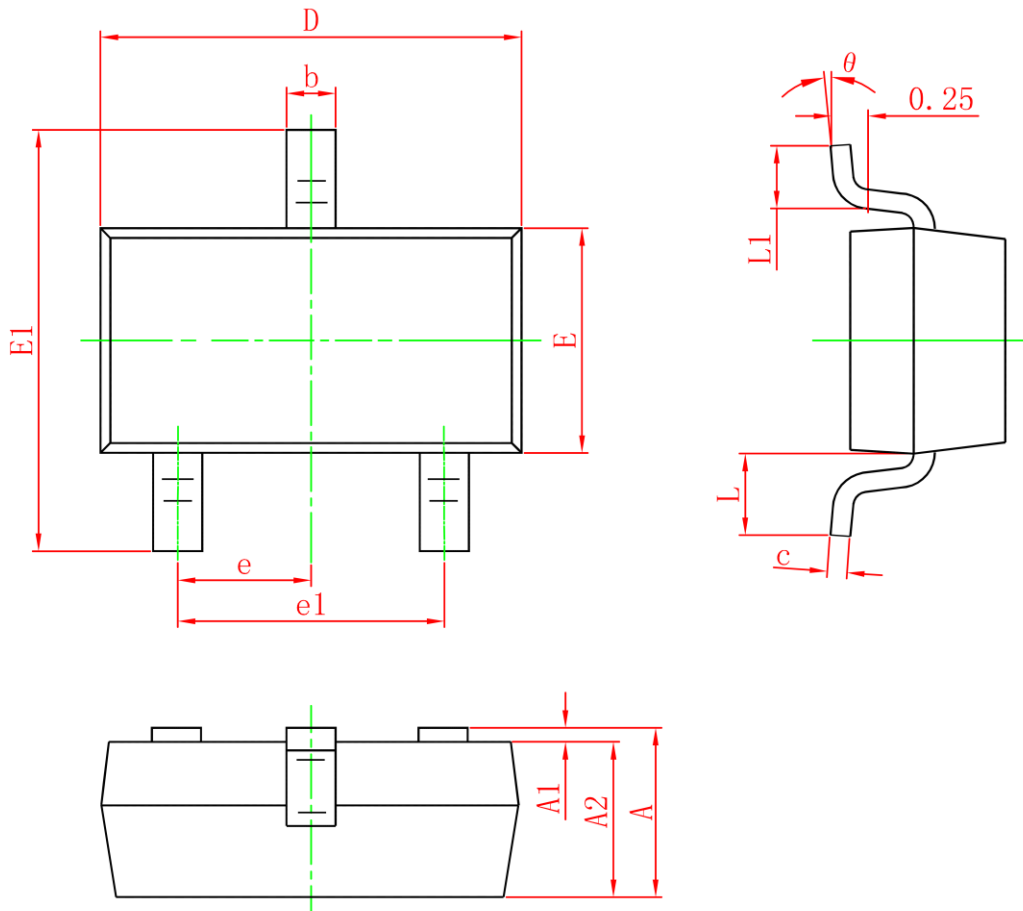
Notes :

1. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
2. These parameters have no way to verify.

Typical Electrical and Thermal Characteristics



SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.300	0.035	0.051
A1	0	0.100	0	0.004
A2	0.900	1.200	0.035	0.047
b	0.300	0.550	0.012	0.022
c	0.080	0.158	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.150	1.500	0.045	0.059
E1	2.200	2.700	0.087	0.106
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

Attention:

- GreenPower Electronics reserves the right to improve product design function and reliability without notice.
- Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.
- GreenPower Electronics products belong to consumer electronics or other civilian electronic products.